

KLAUS J. BACH & ASSOCIATES
4407 TWIN OAKS DRIVE
MURRYSVILLE PA 15668 USA

22154 U.S. PTO
10/677606
100203

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re: Patent Application to be filed under 35 U.S.C. par. 120 as a Continuation-In-Part
Application of US Application 09/961,003 filed 21/09/01 and claiming priority of
German Patent Application No. 100 46 899.3 filed on 21/09/00.

Docket No.: TD 146
Inventors: Uwe Waeckerle

Title: METHOD OF TRANSFERRING SEMICONDUCTOR CHIPS

Honorable Commissioner of Patents and Trademarks
2900 Crystal Drive, Arlington VA 22202-3513
BOX PATENT APPLICATION

Date: 10/1/2003

TRANSMITTAL LETTER FOR CIP PATENT APPLICATION UNDER 35 U.S.C.-120

Sir:

Please find enclosed herewith the following documents relating to the above-identified case:

1. Specification including 11 pages with 4 claims, 2 drawings
2. Declaration and Power of Attorney
3. Recordation cover sheet and Assignment
4. A return postcard for acknowledgement of receipt

Please charge the fee of \$ 385.00 (Small Entity) to deposit account No. 500465.

Small Entity Status is claimed

Respectfully submitted,

K. Bach

Klaus J. Bach
Reg. No. 26,832
Tel.: 724-327-0664

CERTIFICATE OF MAILING - EXPRESS MAIL

Commissioner of Patents and Trademarks:
Enclosed herewith are the following documents:
Application documents for a utility patent entitled:
METHOD OF TRANSFERRING SEMICONDUCTOR CHIPS
Inventor: Uwe Waeckerle
Docket No: TD 146
specification (11 pages spec. with 4 claim, 2 drawing(s))
Assignment and recordation form cover sheet
Declaration and Power of Attorney
Postcard for acknowledgement of receipt

I hereby certify that the correspondence identified above is being deposited with the United States Postal Service as: **EXPRESS MAIL**

Mailing Label:EJ105524696US

in an envelope addressed to: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

on: 10/2/03

K. Bach

10/2/03

Klaus Bach

date

4407 Twin Oaks Drive

Murrysville, PA 15668